J. R. Fallon - St. Louis

October 7, 1970

C. L. Clay - CCLAY

Clermont Engineering Co.
Philadelphia, Pa.
JSP's call report 9/23/70

J. S. PULLMAN
NEW YORK

Jay, in the referenced call report you mention that you had discussed the C. J. Patterson job in Kansas City as it relates to the PCB situation. Carl Clay has been in contact with C. J. Patterson and in essence we have advised them that it looks feasible that they should continue with their use of Therminol FR-1. We based this on the following. The product they produce is Verve, an additive for bread. They are very conscious regarding quality control and put the Verve through six separate analysis steps at various times in the process. At any one of these steps they could pick out contamination with Therminol FR-1. In addition only about 1/2 to 1% of the Verve is added to the dough. On this basis we looked upon the overall exposure of contamination from PCB as being negligible. Carl Clay then wrote to C. J. Patterson confirming this and allowing them to continue using FR-1 in the heat transfer loop. At the same time we pointed out to them the overall concern on PCB and that at some future time there may be additional guidelines on it.

Regards,

J. R. Fallon

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